

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
CHARLOTTE A. SMITH	04/02/2007
VIVIENNE S. MARSHALL	04/02/2007
CATHERINE J. TRUMPOWER	04/02/2007
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<b>State/Country:</b>	PENNSYLVANIA
<b>Postal Code:</b>	15219
<b>PROPERTY NUMBERS Total: 2</b>	
<b>Property Type</b>	<b>Number</b>
<b>Patent Number:</b>	8187881
<b>Patent Number:</b>	8796025
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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<b>SIGNATURE:</b>	/Angela Heukeshoven/
<b>DATE SIGNED:</b>	04/25/2023
<b>Total Attachments: 2</b>	
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**ASSIGNMENT OF APPLICATION FOR PATENT**

WHEREAS:

Charlotte A. Smith, a citizen of the United States, residing at 1417 Fallowfield Avenue, Pittsburgh, PA 15216, Catherine J. Trumpower, a citizen of the United States, residing at 260 Cascade Road, Pittsburgh, PA 15221, and Vivienne S. Marshall, a citizen of New Zealand, residing at 594 Kimble Drive, Glenshaw, PA 15116 have made a discovery or invention entitled:

“Methods Related to Wound Healing”

For which application of Letters Patent of the United States has been filed:

[ ] concurrently herewith

[X] was filed as U.S. Patent Application Serial No.11/724,094 on March 14, 2007;

WHEREAS:

STEMNION LLC, a Delaware Limited Liability Corporation having a principal place of business at 100 Technology Drive, Suite 200, Pittsburgh, PA 15219 (hereinafter ASSIGNEE)

is desirous of acquiring the entire interest in, to and under said discovery or invention and in, to and under all Letters Patent or similar legal protection to be obtained therefore in the United States of America and in all foreign countries.

NOW, THEREFORE, in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of one dollar (\$1.00) or the equivalent thereof, the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE, its successors, legal representatives and assigns, the full and exclusive right, title and interest to said discovery or invention in the United States of America and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in all foreign countries to be obtained for said discovery or invention by said application or any continuation, divisional, continuation-in-part, renewal, extension, substitute or reissue thereof or any legal equivalent thereof in a foreign country for the full term or terms for which the same may be granted.

SAID ASSIGNOR hereby authorizes and requests the Commissioner for Patents of the United States of America and any Official of any countries foreign to the United States of America whose duty it is to issue Letters Patent on applications as aforesaid, to issue all such Letters Patent for said discovery or invention to the ASSIGNEE, as assignee of the

entire right, title and interest in, to and under the same, for the sole use and behalf of the ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

SAID ASSIGNOR hereby covenants that ASSIGNOR has the full right to convey the entire right, title and interest herein sold, assigned, transferred and set over to ASSIGNEE.

AND SAID ASSIGNOR hereby further covenants and agrees that the ASSIGNEE, its successors, legal representatives and assigns, may apply for foreign Letters Patent on said discovery or invention and claim the benefits of the International Convention, and that ASSIGNOR will, at any time, when called upon to do so by the ASSIGNEE, its successors, legal representatives, or assigns, communicate to the ASSIGNEE, its successors, legal representatives, or assigns, as the case may be, any facts known to ASSIGNOR respecting said discovery or invention, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title of said discovery or invention, said applications and said Letters Patent and that if reissues of said Letters Patent or disclaimers relating thereto, or continuations, divisionals or refilings of said applications shall hereafter be desired by the ASSIGNEE, its successors, legal representatives or assigns, ASSIGNOR will, at any time, when called upon to do so by the ASSIGNEE, its successors, legal representatives, or assigns, sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers for all continuation, divisional and reissue applications so desired, and do all lawful acts requisite for the application for such reissues and the procuring thereof and for the filing of such disclaimers and such applications, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said discovery or invention in the United States of America an all foreign countries, all without further compensation but at the expense of the ASSIGNEE, its successors, legal representatives and assigns.

Date: 4/2/07Name: C. SmithDate: 4/2/07Name: William J. IngramDate: 4/2/07Name: W. Marshall